XN06211 (XN6211)

Silicon NPN epitaxial planer transistor

For switching/digital circuits

Features

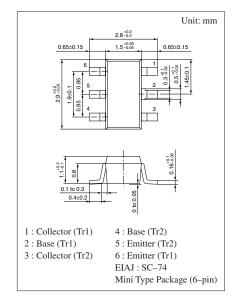
- Two elements incorporated into one package. (Transistors with built-in resistor)
- Reduction of the mounting area and assembly cost by one half.

Basic Part Number of Element

• UNR1211(UN1211) × 2 elements

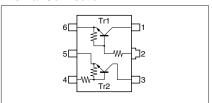
Absolute Maximum Ratings (Ta=25°C)

Parameter		Symbol	Ratings	Unit	
Rating of element	Collector to base voltage	V_{CBO}	50	V	
	Collector to emitter voltage	V_{CEO}	50	V	
	Collector current	I_{C}	100	mA	
Overall	Total power dissipation	P_{T}	300	mW	
	Junction temperature	T _j	150	°C	
	Storage temperature	T_{stg}	-55 to +150	°C	



Marking Symbol: 7Z

Internal Connection

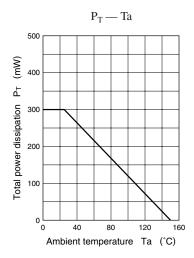


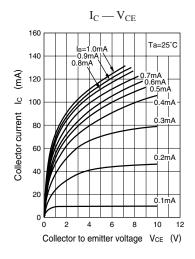
Electrical Characteristics (Ta=25°C)

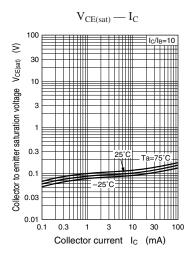
Parameter	Symbol	Conditions	min	typ	max	Unit
Collector to base voltage	V _{CBO}	$I_C = 10 \mu A, I_E = 0$	50			V
Collector to emitter voltage	V_{CEO}	$I_C = 2mA, I_B = 0$	50			V
Collector cutoff current	I_{CBO}	$V_{CB} = 50V, I_{E} = 0$			0.1	μА
Conector cutoff current	I_{CEO}	$V_{CE} = 50V, I_B = 0$			0.5	μΑ
Emitter cutoff current	I_{EBO}	$V_{EB} = 6V, I_C = 0$			0.5	mA
Forward current transfer ratio	h_{FE}	$V_{CE} = 10V, I_C = 5mA$	35			
Forward current transfer h _{FE} ratio	h _{FE} (small/large)*1	$V_{CE} = 10V, I_C = 5mA$	0.5	0.99		
Collector to emitter saturation voltage	V _{CE(sat)}	$I_C = 10 \text{mA}, I_B = 0.3 \text{mA}$			0.25	V
Output voltage high level	V _{OH}	$V_{CC} = 5V, V_B = 0.5V, R_L = 1k\Omega$	4.9			V
Output voltage low level	V _{OL}	$V_{CC} = 5V$, $V_B = 2.5V$, $R_L = 1k\Omega$			0.2	V
Transition frequency	f_T	$V_{CB} = 10V$, $I_E = -2mA$, $f = 200MHz$		150		MHz
Input resistance	R ₁		-30%	10	+30%	kΩ
Resistance ratio	R ₁ /R ₂		0.8	1.0	1.2	

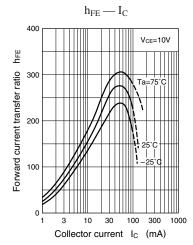
^{*1} Ratio between 2 elements

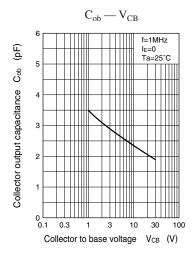
Note.) The Part number in the Parenthesis shows conventional part number.



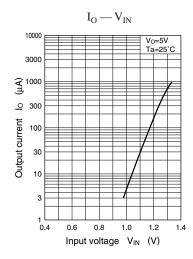


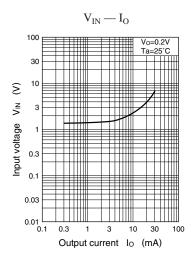






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